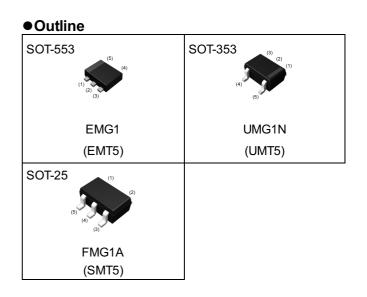
EMG1 / UMG1N / FMG1A

Emitter common(dual digital transistors)

Parameter	DTr1 and DTr2
V _{CC}	50V
I _{C(MAX.)}	100mA
R ₁	22kΩ
R ₂	22kΩ

Features

- 1)Two DTC124E chips in a EMT or UMT or SMT package.
- 2)Mounting cost and area can be cut in half.



(4)

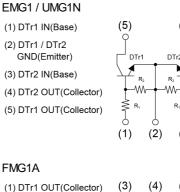
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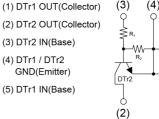
(3)

(5)

(1)

Inner circuit





• Application INVERTER, INTERFACE, DRIVER

• Packaging specifications

Part No.	Package	Package size	Taping code	Reel size (mm)	Tape width (mm)	Basic ordering unit.(pcs)	Marking
EMG1	SOT-553 (EMT5)	1616	T2R	180	8	8000	G1
UMG1N	SOT-353 (UMT5)	2021	TR	180	8	3000	G1
FMG1A	SOT-25 (SMT5)	2928	T148	180	8	3000	G1

• Absolute maximum ratings ($T_a = 25^{\circ}C$)

<For DTr1 and DTr2 in common>

F	Parameter	Symbol	Values	Unit
Supply voltage		V _{CC}	50	V
Input voltage		V _{IN}	-10 to 40	V
Output current		Ι _Ο	30	mA
Collector current		I _{C(MAX)} *1	100	mA
Power dissipation	EMG1	P _D *2*3	150	
	UMG1N	P _D *2*3	150	mW
	FMG1A	P _D *2*4	300	
Junction temperature		Tj	150	°C
Range of storage temperature		T _{stg}	-55 to +150	°C

• Electrical characteristics (T_a = 25°C)

<For DTr1 and DTr2 in common>

Deremeter	Oursela e l	Conditions	Values			L lucit	
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit	
	V _{I(off)}	V _{CC} = 5V, I _O = 100µA		-	0.5		
Input voltage	V _{I(on)}	V _O = 0.2V, I _O = 5mA	3.0	-	-	V	
Output voltage	V _{O(on)}	$V_{O(on)}$ I _O = 10mA, I _I = 0.5mA		100	300	mV	
Input current I ₁ Output current I _{O(off)}		V _I = 5V	-	-	360	μA	
		V _{CC} = 50V, V _I = 0V	-	-	500	nA	
DC current gain	G	V _O = 5V, I _O = 5mA	56	-	-	-	
Input resistance	R ₁	-	15.4	22	28.6	kΩ	
Resistance ratio	R_2/R_1	-	0.8	1.0	1.2	-	
Transition frequency	f _T *1	V _{CE} = 10V, I _E = -5mA, f = 100MHz	-	250	-	MHz	

*1 Characteristics of built-in transistor.

*2 Each terminal mounted on a reference land.

*3 120mW per element must not be exceeded.

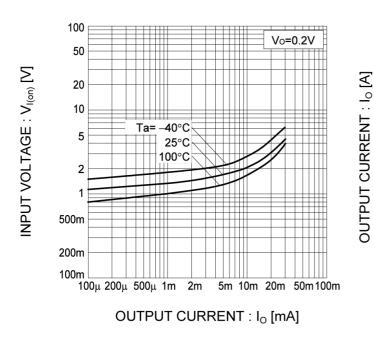
*4 200mW per element must not be exceeded.



• Electrical characteristic curves ($T_a = 25^{\circ}C$)

<For DTr1 and DTr2 in common>

Fig.1 Input Voltage vs. Output Current (ON Characteristics)



(OFF Characteristics)

Fig.2 Output Current vs. Input Voltage

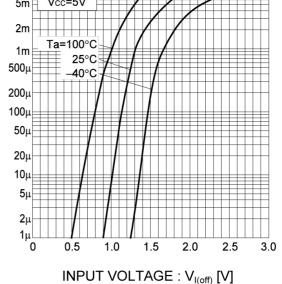


Fig.3 Output Current vs. Output Voltage

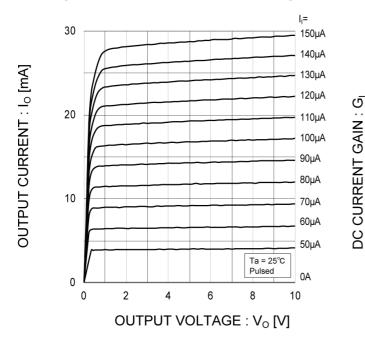
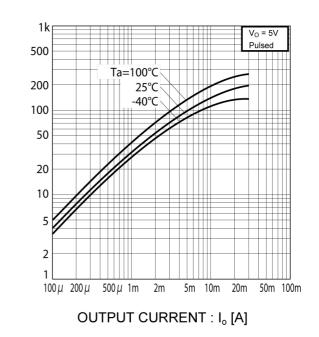


Fig.4 DC Current Gain vs. Output Current



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•Electrical characteristic curves (T_a = 25°C)

<For DTr1 and DTr2 in common>

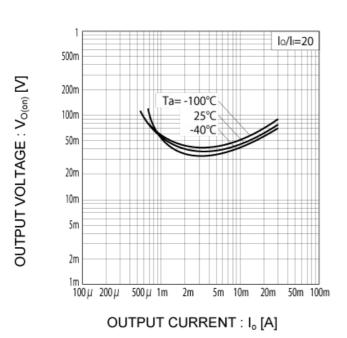
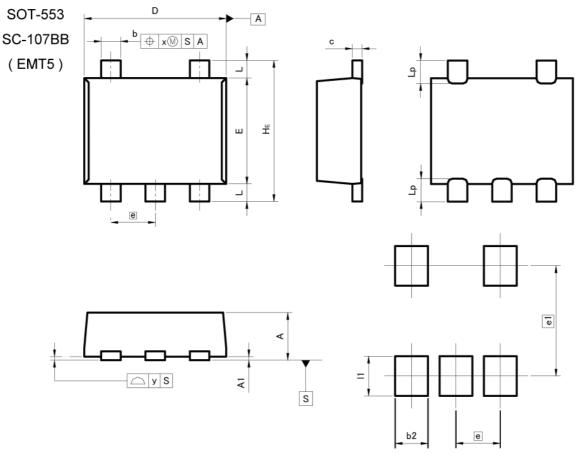


Fig.5 Output Voltage vs. Output Current



Dimensions



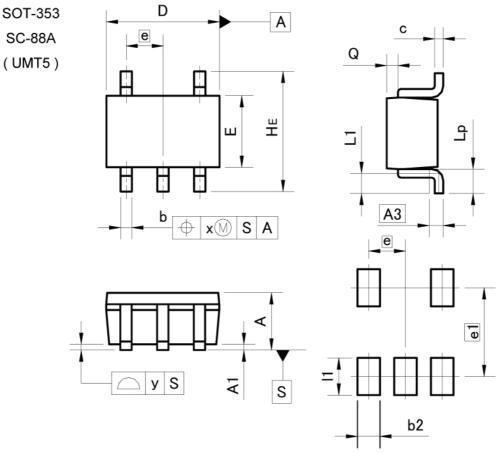
Pattern of terminal position areas [Not a pattern of soldering pads]

DIM	MILIMETERS		INC	HES	
DIM	MIN	MAX	MIN	MAX	
A	0.45	0.55	0.018	0.022	
A1	0.00	0.10	0.000	0.004	
b	0.17	0.27	0.007	0.011	
с	0.08	0.18	0.003	0.007	
D	1.50	1.70	0.059	0.067	
E	1.10	1.30	0.043	0.051	
е	0.50		0.020		
HE	1.50	1.70	0.059	0.067	
L	0.10	0.30	0.004	0.012	
Lp	-	0.35	-	0.014	
x	-	0.10	-	0.004	
У	-	0.10	-	0.004	
DIM	MILIMETERS		INC	HES	
DIM	MIN	MAX	MIN	MAX	
b2	-	0.37	-	0.015	
e1	1.25		0.049		
1		0.45	-	0.018	

Dimension in mm/inches



Dimensions



Pattern of terminal position areas [Not a pattern of soldering pads]

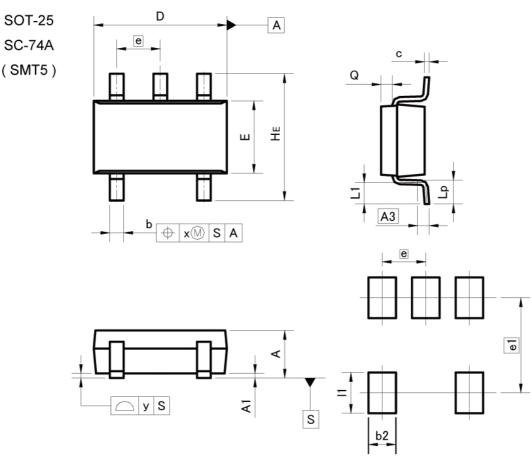
DIM	MILIM	ETERS	INC	HES	
DIM	MIN	MAX	MIN	MAX	
А	0.80	1.00	0.031	0.039	
A1	0.00	0.10	0.000	0.004	
A3	0.	25	0.0	10	
b	0.15	0.30	0.006	0.012	
С	0.10	0.20	0.004	0.008	
D	1.90	2.10	0.075	0.083	
Е	1.15	1.35	0.045	0.053	
е	0.	65	0.026		
HE	2.00	2.20	0.079	0.087	
L1	0.20	0.50	0.008	0.020	
Lp	0.25	0.55	0.010	0.022	
Q	0.10	0.30	0.004	0.012	
х	-	0.10	-	0.004	
У	-	0.10	-	0.004	
DIM	MILIM	ETERS	INC	HES	
DIM					

DIM	MILIMETERS		INCHES		
DIN	MIN	MAX	MIN	MAX	
b2	- 1	0.40	-	0.016	
e1	1.	55	0.0	61	
1	- 0.65		-	0.026	

Dimension in mm/inches



Dimensions



Pattern of terminal position areas [Not a pattern of soldering pads]

DIM	DIM MILIMETERS		INC	HES	
DIM			MIN	MAX	
A	1.00	1.30	0.039	0.051	
A1	0.00	0.10	0.000	0.004	
A3	0.	25	0.0	10	
b	0.25	0.40	0.010	0.016	
с	0.09	0.25	0.004	0.010	
D	2.80	3.00	0.110	0.118	
E	1.50	1.80	0.059	0.071	
е	0.	95	0.037		
HE	2.60	3.00	0.102	0.118	
L1	0.30	0.60	0.012	0.024	
Lp	0.40	0.70	0.016	0.028	
Q	0.20	0.30	0.008	0.012	
х	-	0.20		0.008	
У	-	0.10		0.004	

DIM	MILIMETERS		INCHES		
DIM	MIN		MIN	MAX	
b2	-	0.60	—	0.024	
e1	2.10		0.0	83	
1	-	0.90		0.035	

Dimension in mm/inches



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(Note1) Medical Equipment Classification of the Specific Applications

r				
	JAPAN	USA	EU	CHINA
	CLASSⅢ	CLASSⅢ	CLASS II b	CLASSⅢ
	CLASSⅣ	CLASSIII	CLASSⅢ	CLASSI

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 - [c] Use of our Products in places where the Products are exposed to sea wind or corrosive gases, including Cl₂, H₂S, NH₃, SO₂, and NO₂
 - [d] Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
 - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
 - [f] Sealing or coating our Products with resin or other coating materials
 - [g] Use of our Products without cleaning residue of flux (even if you use no-clean type fluxes, cleaning residue of flux is recommended); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
 - [h] Use of the Products in places subject to dew condensation
- 4. The Products are not subject to radiation-proof design.
- 5. Please verify and confirm characteristics of the final or mounted products in using the Products.
- 6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse. is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
- 7. De-rate Power Dissipation (Pd) depending on Ambient temperature (Ta). When used in sealed area, confirm the actual ambient temperature.
- 8. Confirm that operation temperature is within the specified range described in the product specification.
- 9. ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

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- 2. In principle, the reflow soldering method must be used on a surface-mount products, the flow soldering method must be used on a through hole mount products. If the flow soldering method is preferred on a surface-mount products, please consult with the ROHM representative in advance.

For details, please refer to ROHM Mounting specification

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This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

Precaution for Storage / Transportation

- 1. Product performance and soldered connections may deteriorate if the Products are stored in the places where:
 - [a] the Products are exposed to sea winds or corrosive gases, including Cl2, H2S, NH3, SO2, and NO2
 - [b] the temperature or humidity exceeds those recommended by ROHM
 - [c] the Products are exposed to direct sunshine or condensation
 - [d] the Products are exposed to high Electrostatic
- 2. Even under ROHM recommended storage condition, solderability of products out of recommended storage time period may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

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